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1 SHEET

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U.S. DEPARTMENT OF COMMERCE

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To the Assistant Commissioner for Patents:
Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Takashi SUGINO
Hideo SENOO
Yasukazu NAKATA

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: June 14, 1999

2. Name and address of receiving party(ies):

Name: LINTEC CORPORATION

Internal Address: _____

Street Address: 23-23, Honcho, Itabashi-ku,Tokyo 173-0001, Japan

City: _____

State: _____

ZIP: _____

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application,
the execution date of the application is: June 14, 1999

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Russell D. OrkinInternal Address: Webb Ziesenheim LoqsdonOrkin & Hanson, P.C.Street Address: 700 Koppers Building436 Seventh AvenueCity: Pittsburgh State: PA ZIP: 15219-1818

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41).....\$ 40.00☒ Enclosed☐ Authorized to be charged to deposit account

8. Deposit account number:

(Attach triplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Kent E. Baldauf

Name of Person Signing
Reg. No. 25,826

Kent E. Baldauf
Signature

July 6, 1999

Date

Total number of pages including cover sheet, attachments and document

4

Mail documents to be recorded with required cover sheet information to:
Assistant Commissioner for Patents, Box Assignments
Washington, D.C. 20231

07/15/1999 DNGUYEN 00000275 09347634

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PATENT
REEL: 010089 FRAME: 0027

ASSIGNMENT

WHEREAS, We, See the attached sheet, please.
 and See the attached sheet, please., residing
 in See the attached sheet, please. and
See the attached sheet, please., respectively,
 have invented certain new and useful improvements entitled
ADHESIVE COMPOSITION AND ADHESIVE SHEET
 for which we have this day executed an application for United
 States Letters Patent;

AND, WHEREAS LINTEC CORPORATION, a
 corporation of Japan, having a
 place of business at 23-23, Honcho, Itabashi-ku, Tokyo 173-0001, Japan
 hereinafter called the "assignee", is desirous of acquiring the
 entire right, title, and interest in and to said application and
 the inventions and improvements therein disclosed.

NOW, THEREFORE, in consideration of One (\$1.00) Dollar
 and other good and valuable consideration paid to us by said
 assignee, the receipt of which is hereby acknowledged, we do
 hereby assign, sell, transfer, and set over unto said assignee
 the entire right, title and interest in and to said application
 and the inventions and improvements therein disclosed for the
 United States and all foreign countries and any Letters Patent
 which may issue therefor in the United States and all foreign
 countries and all divisions, reissues, continuations, renewals,
 and/or extensions thereof, said assignee to have and to hold the
 interests herein assigned to the full ends of the terms of said
 Letters Patent and any and all divisions, reissues,
 continuations, renewals, and/or extensions thereof, respectively,
 as fully and entirely as the same would have been held and
 enjoyed by us had this assignment not been made.

The Commissioner of Patents and Trademarks is requested
 to issue such Letters Patent in accordance herewith. We covenant
 that we are the lawful owners of the said application,
 inventions, and improvements, that the same are unencumbered,
 that no license has been granted to make, use, or vend the said
 inventions or improvements or any of them, and that we have the
 full right to make this assignment.

And for the consideration aforesaid, we agree jointly
 and individually that we will communicate to said assignee or the
 representatives thereof any facts known to us respecting said
 inventions and improvements, and will, upon request, but without
 expense to us, testify in any legal proceedings, sign all lawful
 papers, execute all divisional, reissue, continuation, renewal,
 and/or extension applications, make all rightful oaths, and
 generally do all other and further lawful acts, deemed necessary
 or expedient by said assignee or by counsel for said assignee, to
 assist or enable said assignee to obtain and enforce full
 benefits from the rights and interests herein assigned. This
 assignment shall be binding upon our heirs, executors,

administrators, and/or assigns, and shall inure to the benefit of the heirs, executors, administrators, successors, and/or assigns, as the case may be, of said assignee.

EXECUTED June 14, , 19 99 .

Takashi Sugino
Takashi SUGINO

Hideo Senoo
Hideo SENOO

Yasukazu Nakata
Yasukazu NAKATA

Toshihisa Shibasaki
Witness

Shinji Hageman
Witness

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